

## Description

The HXY3401MI uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

#### **General Features**

 $V_{DS} = -30V I_D = -4.2A$  $R_{DS(ON)} < 54m\Omega@V_{GS} = 10V$  $R_{DS(ON)} < 77m\Omega@V_{GS} = 4.5V$ 

# Application

Battery protection Load switch Uninterruptible power supply

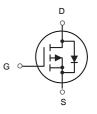
### Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
HXY3401MI	SOT23-3L	X1KX	3000

### Absolute Maximum Ratings (T<sub>A</sub>=25<sup>°</sup>C unless otherwise noted)

Symbol	Parameter	Limit	Unit
Vds	Drain-Source Voltage	-30	V
Vgs	Gate-Source Voltage	±12	V
ID	Drain Current-Continuous	-4.2	A
Іом	Drain Current-Pulsed (Note 1)	-30	A
PD	Maximum Power Dissipation	1.2	W
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	°C
Reja	Thermal Resistance, Junction-to-Ambient (Note 2)	104	°C/W





P-Channel MOSFET



## Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ =-24V, $V_{GS}$ =0V	-	-	-1	μA
Gate-Body Leakage Current	Igss	V <sub>GS</sub> =±10V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =-250µA	-0.7	-1	-1.3	V
	R <sub>DS(ON)</sub>	V <sub>GS</sub> =-10V, I <sub>D</sub> =-4.2A	-	46	54	mΩ
Drain-Source On-State Resistance		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-4A	-	58	77	mΩ
		V <sub>GS</sub> =-2.5V, I <sub>D</sub> =-1A		74	130	mΩ
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =-5V,I <sub>D</sub> =-4.2A	-	10	-	S
Dynamic Characteristics (Note4)	·					
Input Capacitance	C <sub>lss</sub>	- V <sub>DS</sub> =-15V,V <sub>GS</sub> =0V, F=1.0MHz	-	880	-	PF
Output Capacitance	C <sub>oss</sub>		-	105	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	65	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	7	-	nS
Turn-on Rise Time	tr	V <sub>DD</sub> =-15V,I <sub>D</sub> =-4.2A V <sub>GS</sub> =-10V,R <sub>GEN</sub> =6Ω	-	3	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>		-	30	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	12	-	nS
Total Gate Charge	Qg	V <sub>DS</sub> =-15V,I <sub>D</sub> =-4.2A,V <sub>GS</sub> =-4.5V	-	8.5	-	nC
Gate-Source Charge	Q <sub>gs</sub>		-	1.8	-	nC
Gate-Drain Charge	Q <sub>gd</sub>		-	2.7	-	nC
Drain-Source Diode Characteristics		•				
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =-4.2A	-	-	-1.2	V

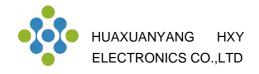
#### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

**2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.

**3.** Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.

4. Guaranteed by design, not subject to production



Typical Electrical and Thermal Characteristics

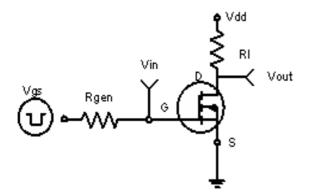
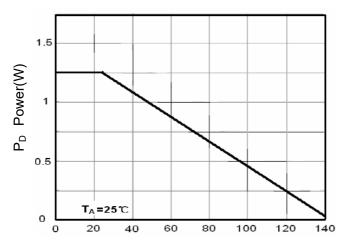
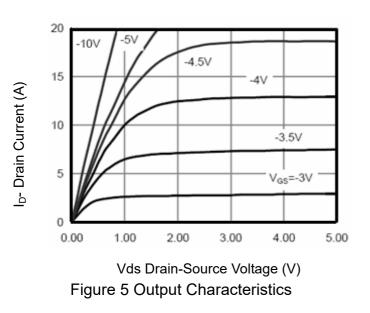


Figure 1:Switching Test Circuit



 $T_J$ -Junction Temperature(°C) Figure 3 Power Dissipation



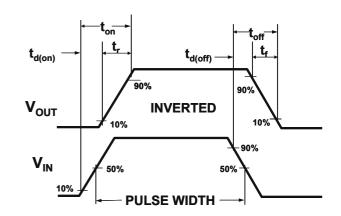
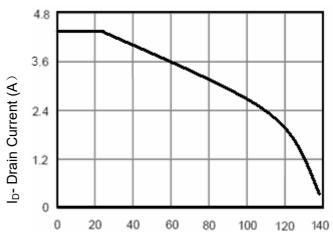


Figure 2:Switching Waveforms



T<sub>J</sub>-Junction Temperature(℃) Figure 4 Drain Current

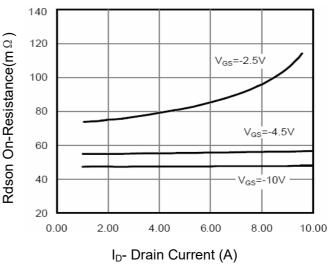
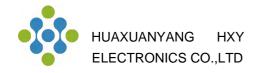
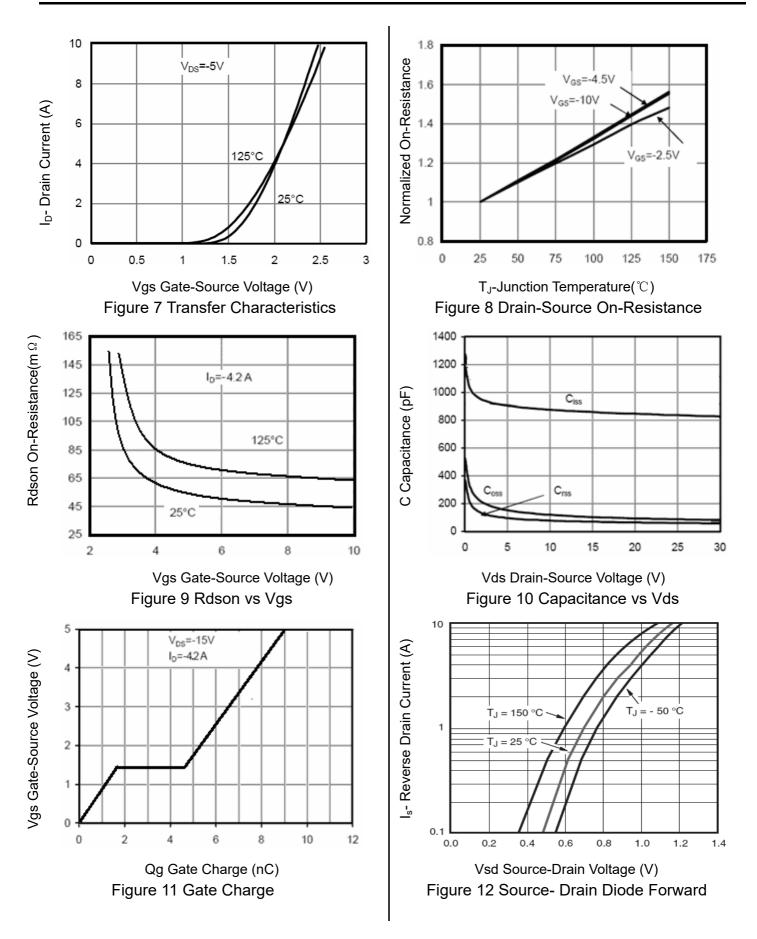
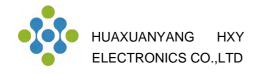
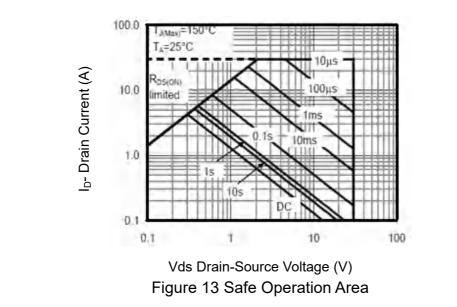


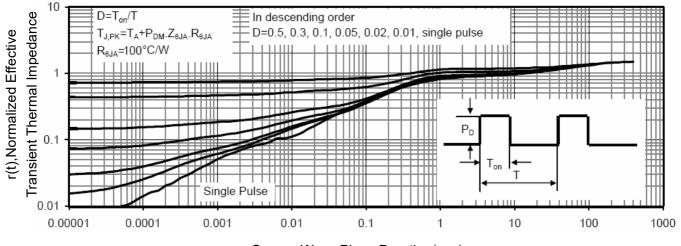
Figure 6 Drain-Source On-Resistance







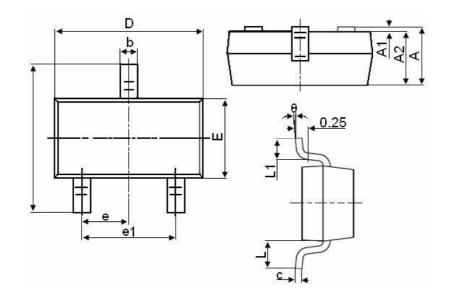




Square Wave Pluse Duration(sec) Figure 14 Normalized Maximum Transient Thermal Impedance



# SOT23-3L Package Information



Symbol	Dimensions in Millimeters		
	MIN.	MAX.	
A	1.050	1.250	
A1	0.000	0.100	
A2	1.050	1.150	
b	0.300	0.500	
с	0.100	0.200	
D	2.800	3.000	
E	1.500	1.700	
E1	2.650	2.950	
е	0.950TYP		
e1	1.800	2.000	
L	0.550REF		
L1	0.300	0.600	
θ	0°	8°	



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